

1.6x0.2mm RIGHT ANGLE SMD CHIP LED **LAMP**

Part Number: KPGA-1602SEC-E-KA Hyper Red

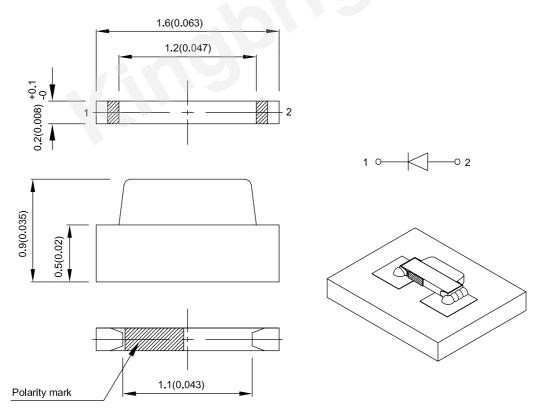
Features

- 1.6x0.9x0.2mm right angle SMD LED, 0.2mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Moisture sensitivity level : level 3.
- Package :2000pcs / reel.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
KPGA-1602SEC-E-KA	Hyper Red (AlGaInP)	Water Clear	80	200	- 150°
			*55	*120	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	632		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	624		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	25		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.05	2.4	V	I=20mA
lR	Reverse Current	Hyper Red		10	uA	V _R =5V

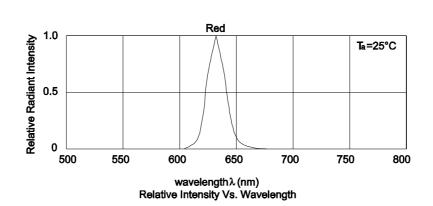
- Notes: 1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units		
Power dissipation	48	mW		
DC Forward Current	20	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C	-40°C To +85°C		
Storage Temperature	-40°C To +100°C	-40°C To +100°C		

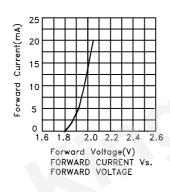
- Notes:
 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

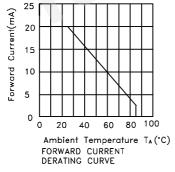
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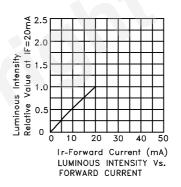


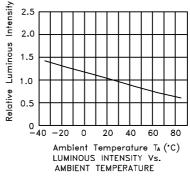
Hyper Red

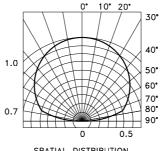
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SPATIAL DISTRIBUTION

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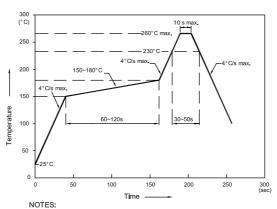
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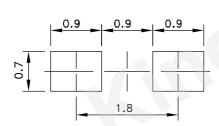
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



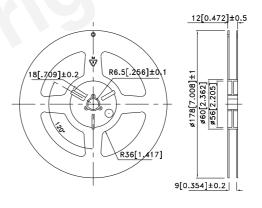
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

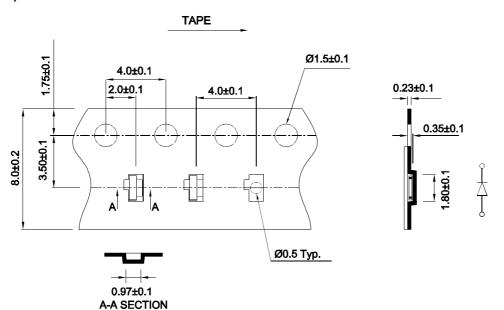
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

Reel Dimension

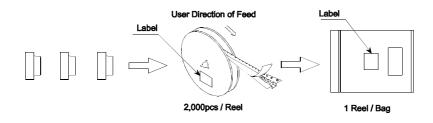


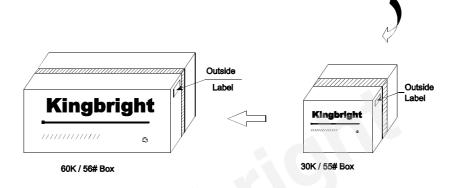


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PACKING & LABEL SPECIFICATIONS

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